MAAPGM0060

Features

- 5 Watt Saturated Output Power Level
- Variable Drain Voltage (6-10V) Operation
- ◆ GaAS MSAG[™] MESFET Process

Primary Applications

- Point-to-Point Radio
- SatCom
- UNII and ISM Band

Description

The MAAPGM0060 is a 2-stage 5 W power amplifier with on-chip bias networks in a bolt down ceramic package, allowing easy assembly. This product is fully matched to 50 ohms on both the input and output. It can be used as a power amplifier stage or as a driver stage in high power applications.

Each device is 100% RF tested to ensure performance compliance. The part is fabricated using M/A-COM's GaAs Multifunction Self-Aligned Gate MESFET Process. M/A-COM's MSAG[™] process features robust silicon-like manufacturing processes, planar processing of ion implanted transistors and multiple implant capability enabling power, low-noise, switch and digital FETs on a single chip. The use of refractory metals and the absence of platinum in the gate metal formulation prevents hydrogen poisoning when employed in hermetic packaging.

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Pin Number RF Designa		
1	No Connection	
2	V_{GG}	
3	RF IN	
4	V _{GG}	
5	No Connection	
6	V _{DD1}	
7	V _{DD2}	
8	RF OUT	
9	V _{DD2}	
10	V _{DD1}	

Parameter	Symbol	Absolute Maximum	Units
Input Power	P _{IN}	25.0	dBm
Drain Supply Voltage	V _{DD}	+12.0	V
Gate Supply Voltage	V _{GG}	-3.0	V
Quiescent Drain Current (No RF)	I _{DQ}	3	A
Quiescent DC Power Dissipated (No RF)	P _{DISS}	27	W
Junction Temperature	TJ	180	°C
Storage Temperature	T _{STG}	-55 to +150	°C

Maximum Operating Conditions¹

1. Operation outside of these ranges may reduce product reliability.

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Recommended Operating Conditions

Characteristic	Symbol	Min	Тур	Мах	Unit
Drain Supply Voltage	V _{DD}	6.0	8.0	10.0	V
Gate Supply Voltage	V _{GG}	-2.4	-1.8	-1.5	V
Input Power	P _{IN}		20.0	23.0	dBm
Junction Temperature	TJ			150	°C
Thermal Resistance	Θ _{JC}		3.7		°C/W
Package Base Temperature	Τ _Β			Note 2	°C

2. Maximum Package Base Temperature = 150°C — $\Theta_{JC}^* V_{DD}^* I_{DQ}$

Electrical Characteristics: $T_B = 40^{\circ}C^2$, $Z_0 = 50 \Omega$, $V_{DD} = 8V$, $I_{DQ} \approx 1.85 A^3$, $P_{in} = 20 \text{ dBm}$, $R_G = 100\Omega$

Parameter	Symbol	Typical	Units
Bandwidth	f	4.8-6.7	GHz
Output Power	POUT	37	dBm
Power Added Efficiency	PAE	29	%
1-dB Compression Point	P1dB	37	dBm
Small Signal Gain	G	18	dB
Input VSWR	VSWR	3:1	
Output VSWR	VSWR	1.5:1	
Gate Supply Current	l _{GG}	< 4	mA
Drain Supply Current	I _{DD}	<2.5	A

3. Adjust V_{GG} between –2.4 to -1.5 to achieve indicated I_{DQ} .



Static-Sensitive Devices Handling Precautions Required

Operating Instructions

This device is static sensitive. Please handle with care. To operate the device, follow these steps.

- 1. Apply $V_{GG} = -1.8 \text{ V}, V_{DD} = 0 \text{ V}.$
- 2. Ramp V_{DD} to desired voltage, typically 8 V.
- 3. Adjust V_{GG} to set $I_{\text{DQ}}\text{,}$ (approxmately @ –1.8V).
- 4. Set RF input.
- 5. Power down sequence in reverse. Turn gate voltage off last.

Specifications subject to change without notice. Email: macom_adbu_ics@tycoelectronics.com

- North America: Tel. (800) 366-2266
- Asia/Pacific: Tel.+81-44-844-8296, Fax +81-44-844-8298
- Europe: Tel. +44 (1908) 574 200, Fax+44 (1908) 574 300

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7.0

4.8-6.7 GHz 5W Power Amplifier

40 38 36

34

30 POUT

28

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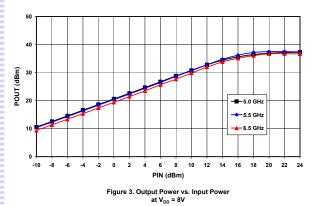
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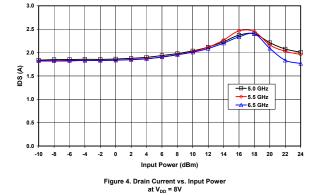
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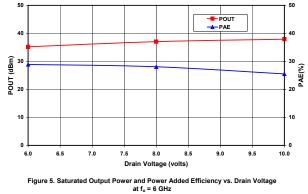
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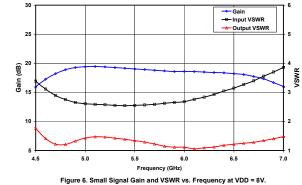
(dBm) 32

40 --- POU 30 P1dB (dBm) 3 PAE(%) - VDD = 6 20 VDD = 8 -VDD = 10 10 10 0 5.0 5.5 6.0 6.5 7.0 4.5 5.0 5.5 6.0 6.5 Frequency (GHz) Frequency (GHz) Figure 1. Output Power and Power Added Efficiency vs. Frequency Figure 2. 1dB Compression Point vs. Drain Voltage at V_{DD} = 8V and P_{in} = 20 dBm









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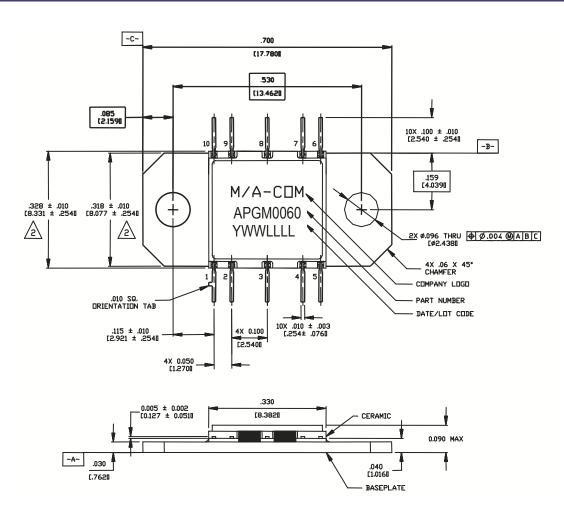


Figure 7. CR-15 Package Dimensions

The CR-15 is a high frequency, low thermal resistance package. The package consists of a cofired ceramic construction with a copper-tungsten base and iron-nickel-cobalt leads. The finish consists of electrolytic gold over nickel plate.

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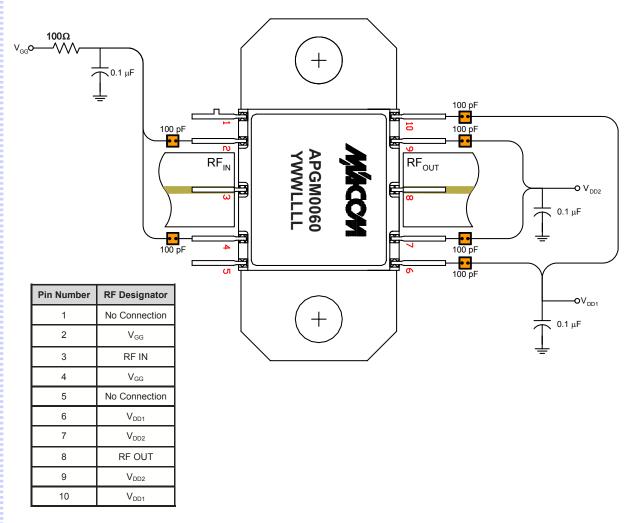
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Assembly Instructions:

This flange mount style package provides a robust interface between a highly integrated GaAs MMIC device and a circuit board which may be assembled using conventional surface mount techniques. A thin shim made of a thermally and electrically conductive, ductile material should be used prior to installation of the CR-15 to improve the thermal and electrical performance of the package to housing interface. Refer to M/A-COM Application Note #M567* for more information .

For applications where surface mount components are to be installed after the CR-15 installation, this package will not be damaged when subjected to typical convection or IR oven reflow profiles. Refer to M/A-COM Application Note #M538* for maximum allowable reflow time and temperature. Alternatively, the package leads may be individually soldered. Whether an iron or hot gas soldering equipment is used, care should be taken to insure that the temperature is well controlled and electric static discharge (ESD) safe.

> * Application Notes can be found by going to the Site Search Page on M/A-COM's web page (http://www.macom.com/search/search.jsp) and searching for the required Application Note.

Biasing Notes:

- The 100pF bypass capacitors must be placed as close to the V_{GG} and $V_{\text{DD}}\,$ pins as possible (recommended < 100 mils).
- A negative bias must be applied to V_{GG} before applying a positive bias to V_{DD} to prevent damage to the amplifier.

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